

Case Docket No. MICRON.170A

Date: March 13, 2003

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In re application of:

Paul A. Farrar

App. No.

09/909,181

Filed

July 19, 2001

For

METHOD OF USING

FOAMED INSULATORS IN THREE DIMENSIONAL

MULTICHIP STRUCTURES

Examiner

Chris C. Chu

Art Unit

2815

overpayment to Deposit Account No. 11-1410.

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first class mail in an envelope addressed to: United States Patent and Trademark Office, P.O. Box 2327, Arlington, VA 22202, on

March 13, 2003

Reg. No. 51,240

UNITED STATES PATENT AND TRADEMARK OFFICE BOX AF P.O. Box 2327 Arlington, VA 22202

Sir:

Transmitted herewith is an amendment after final in the above-identified application.

The fee has been calculated as shown below:

CLAIMS AS FILED										
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDI FEE	TIONA	AL .		
Total Claims	26		32	= 0 ×	\$18	= \$0		_		
Independent Claims	2		3	= 0 ×	\$84	= \$0		_		
If application has been dependent claim(s),		ntain multip	ple		\$280	= \$0				
Time Extension Fee		8				\$0		_		
					DITIONAL FEE MENDMENT	TECHOL	\$0			
(X) Submission drawings.	Submission of Proposed Drawing Amendment for Approval by Examiner with 1-sheet of marked drawings.									
(X) Return prep	oaid postcard.					CENTER	2003	ECEIVED		
(X) Please charg	Please charge any additional fees, including any fees for additional extension of time, or credit no									

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(X) Please use Customer No. 20,995 for the correspondence address.

Linda H. Liu

Registration No. 51,240 Attorney of Record Customer No. 20,995 (909) 781-9231

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Applicant	:	Paul A. Farrar)	Group Art Unit 2815	Cha- 1.Stepto
Appl. No.	:	09/909,181)	I hereby certify that this correspondence marked attachments are being deposited the United States Postal Service as first-	with
Filed	:	July 19, 2001))	mail in an envelope addressed to: Unite Patent and Trademark Office, P.O. Box Arlington, VA 22202, on	
For	:	A METHOD OF USING FOAMED INSULATORS IN)	March 13, 2003 (Date)	- enter
		THREE DIMENSIONAL MULTICHIP STRUCTURES	•)	Linda H. Liu, Reg. No. 51,240	1/2/03
Examiner	:	Chris C. Chu)		`

SUBMISSION OF PROPOSED DRAWING AMENDMENT FOR APPROVAL BY EXAMINER

United States Patent and Trademark Office P.O. Box 2327 Arlington, VA 22202

Dear Sir:

Enclosed please find one (1) sheet of drawing designating the proposed amendment to Figure 5 of the drawings in this application for which approval by the Examiner is requested. The amended drawing is intended to overcome certain objections asserted by the Examiner in the Office Action mailed January 13, 2003 and conform to suggestions made by the Examiner in that same Office Action.

Specifically, numerical references have been added to the drawing to support the fourth insulating layer covered by Claim 17. No new matter is added as the fourth insulating layer shown in the amended drawing is clearly described in Page 3 Line 30 to Page 4 Line 1 of the specification, Page 4 Line 26-28 of the specification, and Claim 17 of the claims as originally filed.

EN OK

Appl. No. Filed

09/909,181 July 19, 2001

Please charge any additional fees, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 11-1410.

Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

By:

Registration No. 51,240

Attorney of Record

Customer No. 20,995

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